A Methodical Approach for the Integration of Foil-Type Strain Gauges in PBF-LB/M Components



Fraunhofer-Institut für Gießerei-, Composite- und Verarbeitungstechnik IGCV

Thomas Bareth^{a,b}, Niklas Fromm^{a,c}, Maja Lehmann^{a,b}, Georg Schlick^a, Christian Seidel^c

^aFraunhofer IGCV (Fraunhofer Institute for Casting, Composite and Processing Technology IGCV), Am Technologiezentrum 10, 86159 Augsburg, Germany

^bTechnical University of Munich, Institute for Machine Tools and Industrial Management, Boltzmannstr. 15, 85748 Garching, Germany

^cMunich University of Applied Sciences, Department of Applied Sciences and Mechatronics, Lothstr. 34, 80335 Munich, Germany

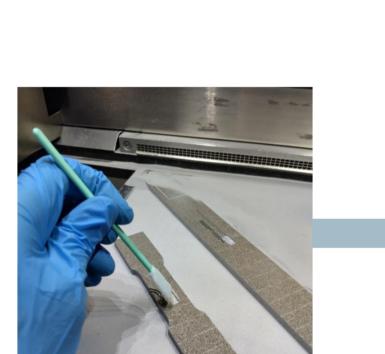
Motivation

- PBF-LB/M enables the integration of sensors through its layer-by-layer manufacturing process, allowing placement near critical regions of interest while providing protection from environmental influences.
- Strain gauge (SG) integration in PBF-LB/M components using adhesive bonding has not been previously demonstrated.
- Research Objective: To establish a reliable and low-cost approach for in-process integration of SGs in PBF-LB/M components.
- **Key challenges** addressed:
 - Temperature monitoring at the integration site
 - Design of sensor and wire cavities
 - Selection of an adhesive ensuring reliable strain transfer
 - Surface preparation to ensure sufficient bonding strength
 - Development of manual integration procedures within the PBF-LB/M environment

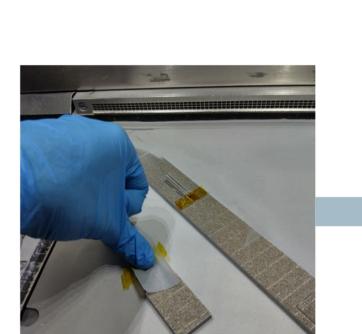
Preparation of required tools and equipment



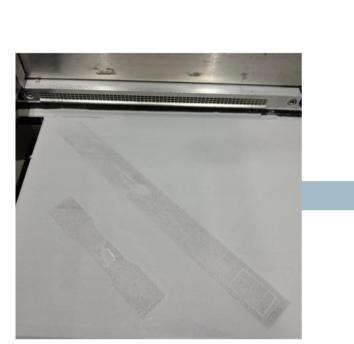
Removal of powder



Cleaning of surface



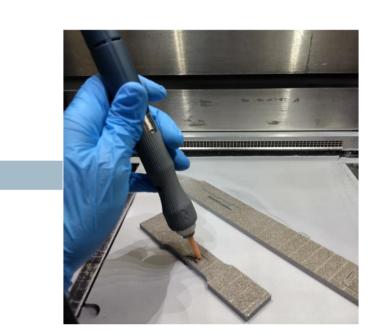
Bonding the SG



Resuming the build job

manual integration of the SG

Opening of process chamber



Mechanical preparation of bonding surface



Alignment of the SG



Completing the sensor integration

Contact

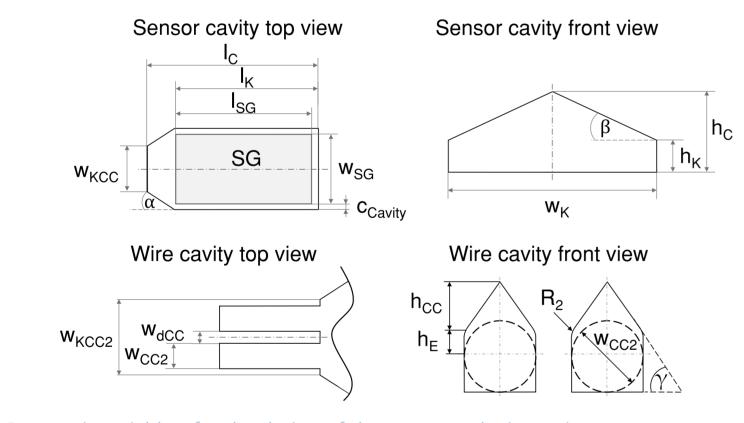
Thomas Bareth, M.Sc.
Additive Manufacturing
thomas.bareth@igcv.fraunhofer.de

Manual integration procedures: Recommended steps during the build interruption and the

Fraunhofer IGCV
Am Technologiezentrum 10
86159 Augsburg
www.igcv.fraunhofer.de

Main results

- Integration methodology for bonded SGs in PBF-LB/M components was developed.
- Build plate temperature was the main factor influencing integration-site temperature; laser parameters had minor impact.
- Method validated through tensile testing, showing accurate and repeatable in-situ strain measurements.



Geometric variables for the design of the sensor and wire cavity

Variable	Description	Variable
α	taper angle	$\alpha = 33^{\circ}$
β	roof angle	$eta=20^\circ$
γ	wire cavity roof angle	$\gamma = 55^{\circ}$
$d_{ m wire}$	diameter of wire	$d_{\text{wire}} = 0.60 \text{ mm *}$
h_{C}	sensor cavity height	$h_{\rm C} = h_{\rm K} + \frac{w_{\rm K} \times \tan \beta}{2}$
$h_{ m CC}$	wire cavity height	$h_{\rm CC} = 1.8 \text{ mm}$
$h_{ m E}$	wire cavity height extension	$h_{\rm E} = 0.9 \; \mathrm{mm}$
$h_{ m K}$	knee cavity height	$h_{\rm K}$ = 1.0 mm
$l_{ m SG}$	SG length	$l_{\rm SG} = 10.9 \text{ mm *}$
$l_{ m K}$	SG length with clearance	$l_{\rm K} = l_{\rm SG} + c_{\rm Cavity}$
$l_{ m C}$	sensor cavity length	$l_{\rm C} = l_{\rm K} + \frac{w_{\rm K} - w_{\rm KCC}}{2 \times \tan \alpha}$
n	number of wire cavities	n=2
$c_{ m Cavity}$	clearance around the SG	$c_{\text{Cavity}} = 0.3 \text{ mm}$
$w_{\rm CC2}$	width of each wire cavity	$w_{\rm CC2} = d_{\rm wire} + 0.6 \text{ mm}$
$w_{ m dCC}$	width of area between wire cavities	$w_{\rm dCC} = 0.6 \text{ mm}$
$w_{ m K}$	width of the cavity	$W_{\rm K} = W_{\rm SG} + c_{\rm Cavity}$
$w_{ m SG}$	SG width	$w_{K} = w_{SG} + c_{Cavity}$ $w_{SG} = 5.9 \text{ mm *}$
$w_{ m KCC2}$	front width of the sensor cavity	$w_{\text{KCC2}} = 2 \times w_{\text{CC2}} + 4 \times 0.3 \text{ mm}$

Recommended geometric variables for the design of the sensor and wire cavities, with

dimensions derived from the SG 3/350 CLY43-3L-1M at the marked positions (*)

a)

Roof
Knee

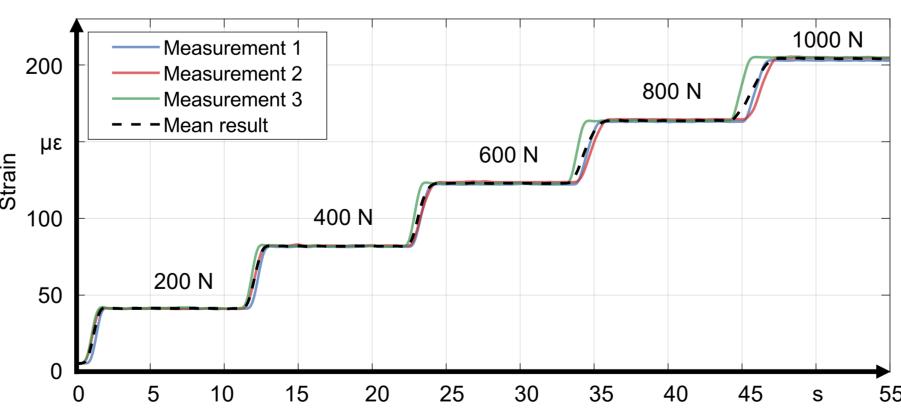
Roof
Knee

Schematic view of the sensor cavity with: a) the separation in a roof and a knee cavity, and b) the position of the SG inside the cavity

a) b) c)

Pradius to fining to finin

a) Schematic representation of the sectioned tensile sample with geometry specifications, b) milled cross-sectional view illustrating the SG integration position, and c) milled PBF-LB/M manufactured tensile sample with integrated SG



Stepwise tensile test ranging from 200 N to 1000 N, repeated three times, with the mean of all measurement results represented by a dashed black line

Conclusion

- Non-weldable SGs successfully integrated into tailored sensor cavities in PBF-LB/M parts using fast-curing cyanoacrylate adhesive
- Improved sensor protection achieved through encapsulation within the component
- Minimal process modifications required, fully compatible with standard PBF-LB/M setups and powder presence
- Method adaptable to various SG types and likely to different materials, requiring only minor design and process parameter adjustments